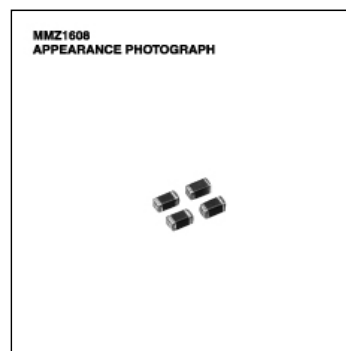



[PAGE BACK](#) [CLOSE](#)

**Product Name**      **Chip Beads**  
**Series**              **MMZ Series**  
**Type**                **1608 Type**  
**Model**              **t=0.8mm**  
**Part Number**      **MMZ1608S102ATA00**

Product Lifecycle Stage    PROD



#### Specification

Mounting Method Flag	Yes	
Processing	MULTI-LAYER	
Shape	Chip	
Number of Circuits	Nom	1
Material Code	S	
Size Code	1608	
Body Length(L)	Nom	1.6 m m
Body Breadth(W)	Nom	0.8 m m
Body Height(T)	Nom	0.8 m m
Impedance	Min	750 Ohm
Impedance	Nom	1000 Ohm
Impedance	Min	-25 %
Impedance Tolerance	Max	25 %
Frequency of Impedance	Nom	100 M Hz
Rated Current	Max	0.4 A
DC Resistance	Max	0.5 Ohm
Soldering Method	Flow,Reflow,Iron Soldering	
Category Temperature	Min	-55 Cel
Range	Max	125 Cel
Storage Temperature Range	Min	-55 Cel
	Max	125 Cel
Weight	Nom	0.004 g

#### Summary/Applications/Feature

Summary	This is a multilayered chip bead product with dimensions of L1.6xW0.8xT0.8mm.
Applications	Personal computers, CRTs, liquid crystal display panels, printers,hard disk drives, game machines, cellular phones, etc.
Feature	The MMZ series provide effective EMC suppression in signal lines through simple in-series implementation. It is applicable for lead free soldering.

#### Packaging

Packing	Punched (Paper)Taping [180mm Reel]	
Minimum Package Qty	Nom	4000 Pcs
Minimum Order Qty	Nom	4000 Pcs

[Details](#)

#### ⚠ [ Caution ]

Specifications which provide more details for the proper and safe use of the described product are available upon request.

#### ⚠ [ Notice of Revision and Improve ]

All specifications are subject to change without notice.

[PAGE TOP](#)

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